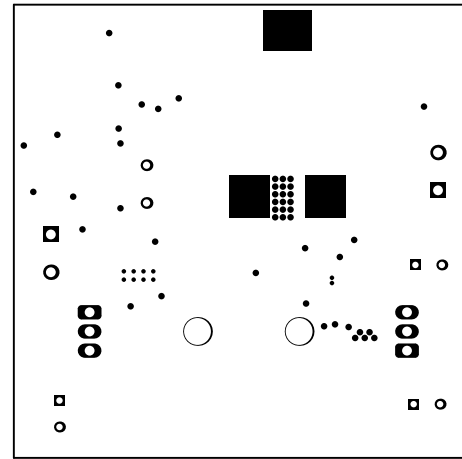
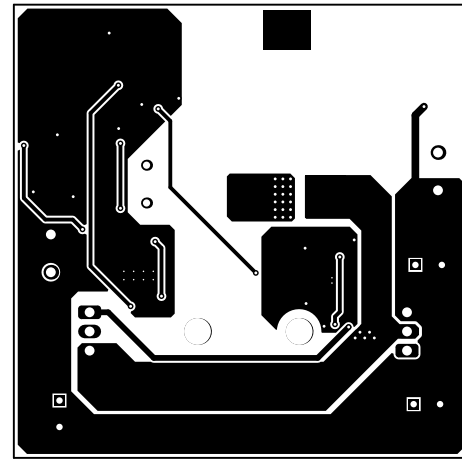


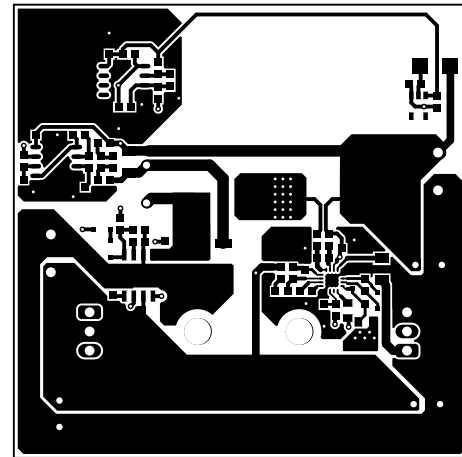
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01558	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01558		
PLOT NAME = Top Overlay	GENERATED : 12/12/2017 12:09:45 PM	TEXAS INSTRUMENTS	



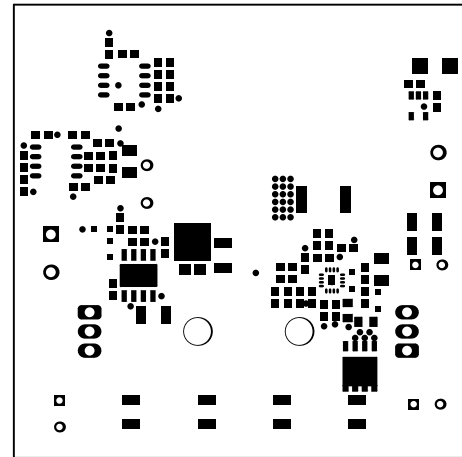
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01558	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01558		
PLOT NAME = Top Solder Mask	GENERATED : 12/12/2017 12:09:46 PM	TEXAS INSTRUMENTS	



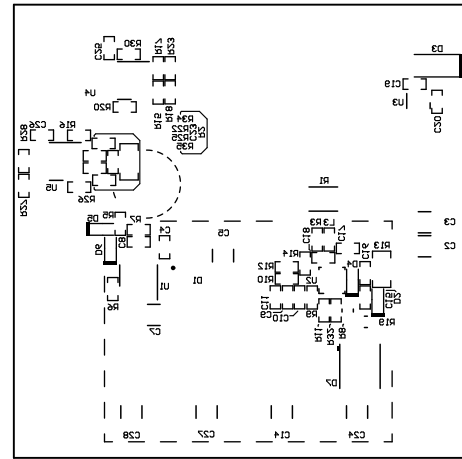
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01558	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01558		
PLOT NAME = Top Layer	GENERATED : 12/12/2017 12:09:46 PM	TEXAS INSTRUMENTS	



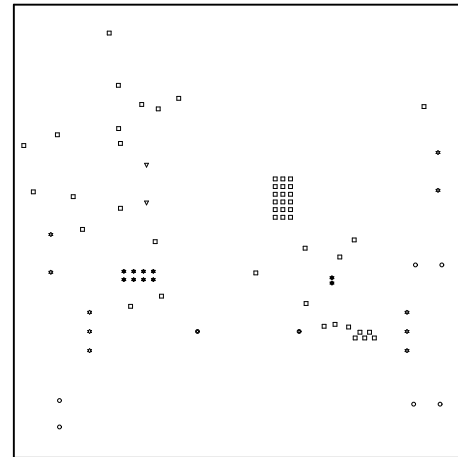
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01558	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01558		
PLOT NAME = Bottom Layer	GENERATED : 12/12/2017 12:09:46 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01558	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01558		
PLOT NAME = Bottom Solder Mask	GENERATED : 12/12/2017 12:09:46 PM	TEXAS INSTRUMENTS	



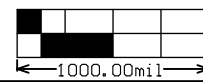
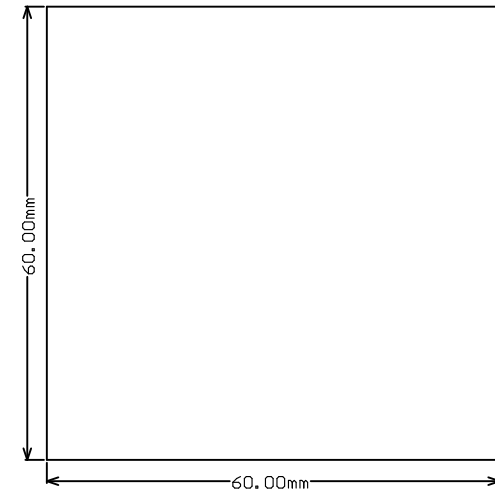
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01558	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01558		
PLOT NAME = Bottom Overlay	GENERATED : 12/12/2017 12:09:46 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
◎	2	140.00mil (3.556mm)	NPTH	Round
✳	10	7.87mil (0.200mm)	PTH	Round
□	48	15.00mil (0.381mm)	PTH	Round
○	6	33.47mil (0.850mm)	PTH	Round
▽	2	37.56mil (0.954mm)	PTH	Round
✳	10	51.18mil (1.300mm)	PTH	Round
	<b>78 Total</b>			

**DRILL TABLE**  
 FOR PTH +3/-3MIL  
 FOR NPTH +2/-2MIL  
 FOR 7.87MIL PTH +0/-7.87MIL  
 FOR 15MIL PTH +0/-15MIL

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01558	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01558		
PLOT NAME = Drill Drawing	GENERATED : 12/12/2017 12:09:46 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01558	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01558		
PLOT NAME = Board Dimensions	GENERATED : 12/12/2017 12:09:47 PM	TEXAS INSTRUMENTS	



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